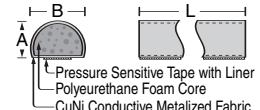




micro D-shape RFI shielding gaskets

WITH VERY HIGH BOND PRESSURE SENSITIVE ADHESIVE MOUNTING. Very similar to the larger D-shaped shielding gaskets above except that the compression force has been scaled to allow for optimum contact resistance properties on such a small cross-sectional profile. Excellent for omni-directional compression loading from any angle. Popular for groove-mounting or surface mounting. Very High Bond pressure sensitive adhesive cures to full strength within 24 hours exhibiting high-tack properties within a very small area – eliminating the need for space-consuming larger profiles such as P-shapes or various mechanical clip-on configurations.



PART No.	Conductive Surface	Surface Resistivity	A	B	Length
SG125187D-24	CuNi	0.005 - 0.010Ω/lin.in	.125	.3,2	.187 4,7 24.0 610
SG125187D-48	CuNi	0.005 - 0.010Ω/lin.in	.125	.3,2	.187 4,7 48.0 1220

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